



Docet No.:YIELD-0002

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Bradley Dale Mitchell

SERIAL NO.: 09/943,569

FILING DATE: August 30, 2001

TITLE: System and Method for Removing Deposited Material from Within a Semiconductor Fabrication Device

EXAMINER: Alexander Markoff

TELEPHONE : (571) 272-1304

FAX: (703) 872-9306

ART UNIT: 1746

RECEIVED  
SEP / 3 2004  
TC 1700

CERTIFICATE OF MAILING

I hereby certify that this paper is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop: Amendment, Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on the date printed below:

Date:

8/30/04

Name:

Beatrice Orozco  
Beatrice Orozco

MAIL STOP: AMENDMENT  
COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
ALEXANDRIA, VA 22313-1450

TRANSMITTAL FOR FORMAL DRAWINGS

With respect to the above-identified patent application, enclosed herewith for filing are nine (9) sheets of Formal Drawings.

Respectfully submitted  
THELEN REID & PRIEST LLP

Dated: August 27, 2004

David B. Ritchie  
Reg. No. 31,562

Thelen Reid & Priest LLP  
P.O. Box 640640  
San Jose, CA 95164-0640  
Tel.: (408) 292-5800  
Fax: (408) 287-8040



RECEIVED  
SEP / 3 2004  
TC 1700

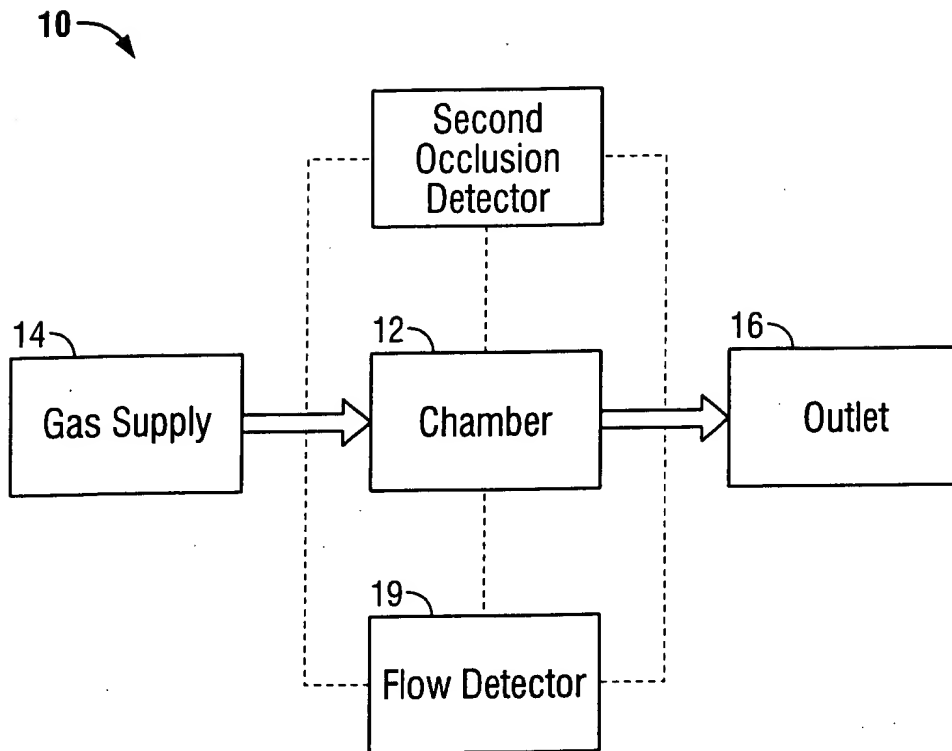


FIG. 1



RECEIVED  
SEP / 3 2004  
TC 1700

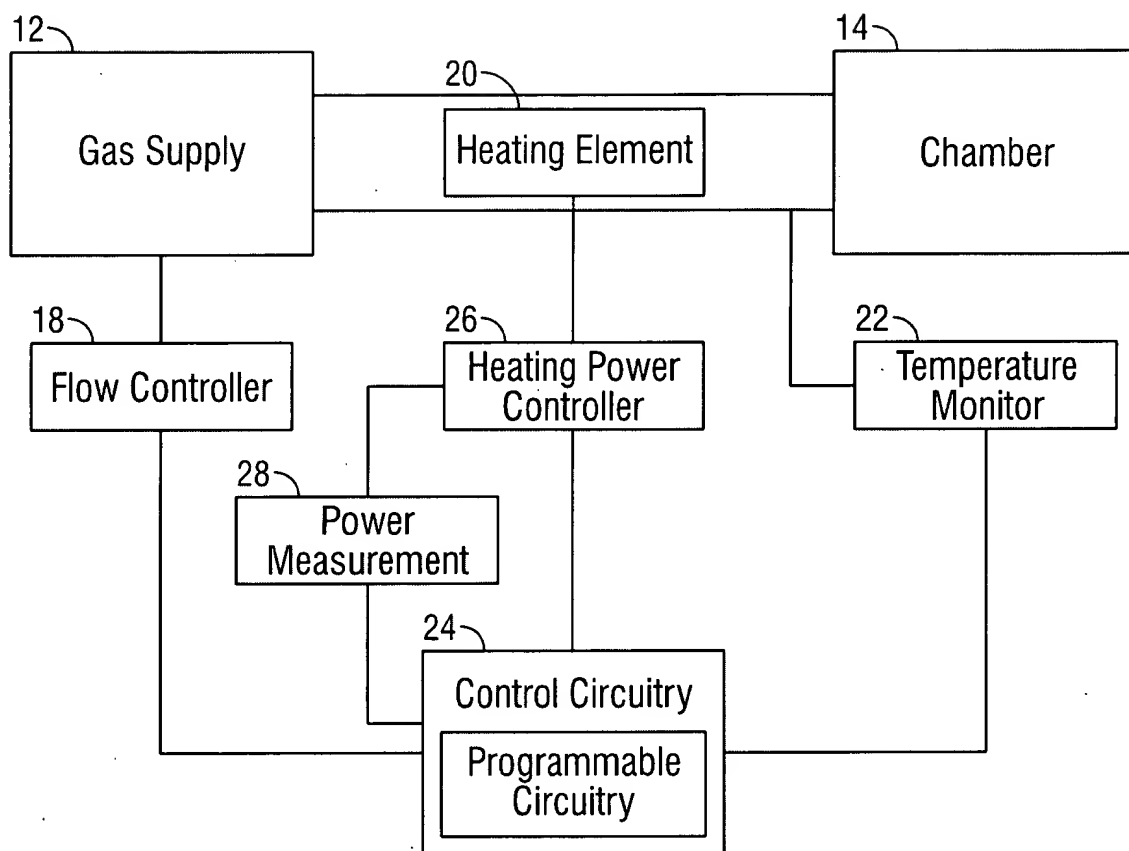


FIG. 2



RECEIVED  
SEP / 3 2004  
TC 1700

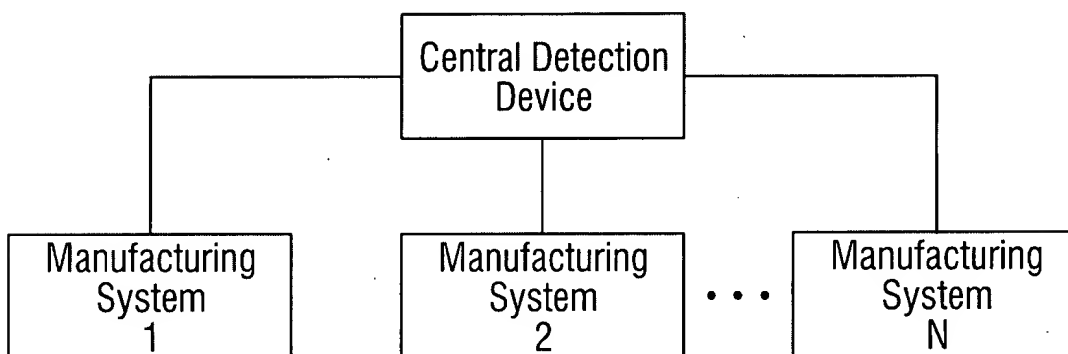


FIG. 3



4/9

RECEIVED  
SEP / 3 2004  
TC 1700

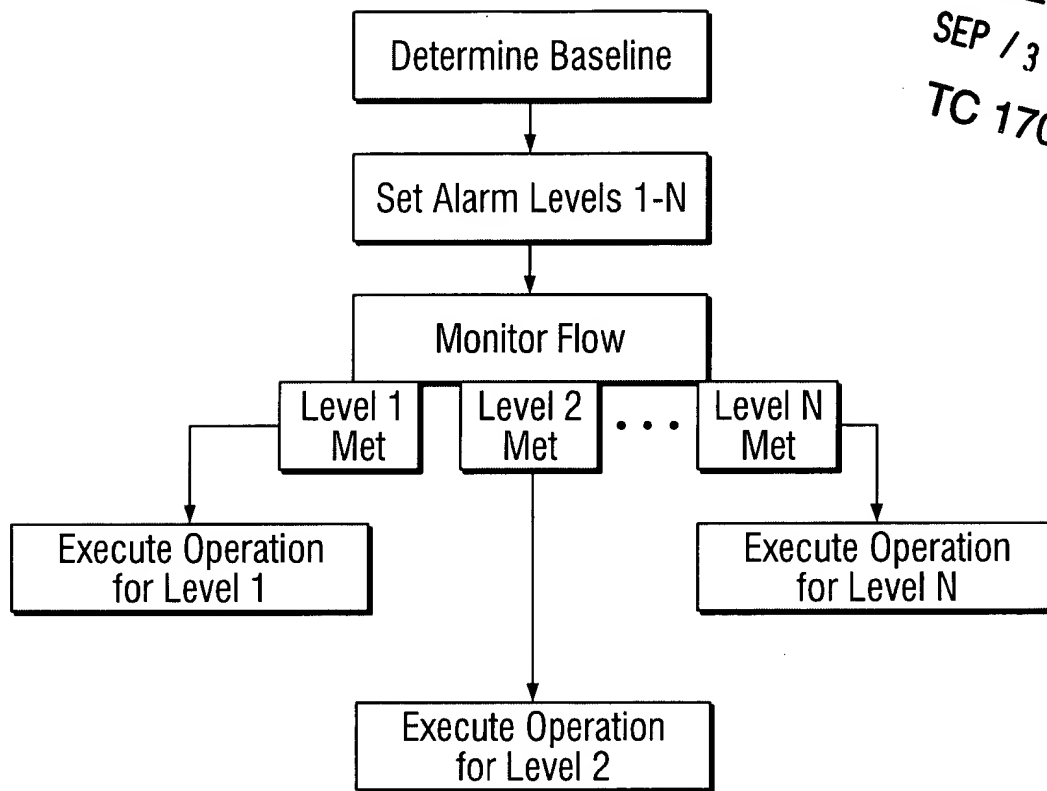


FIG. 4



5/9

RECEIVED  
SEP / 3 2004  
TC 1700

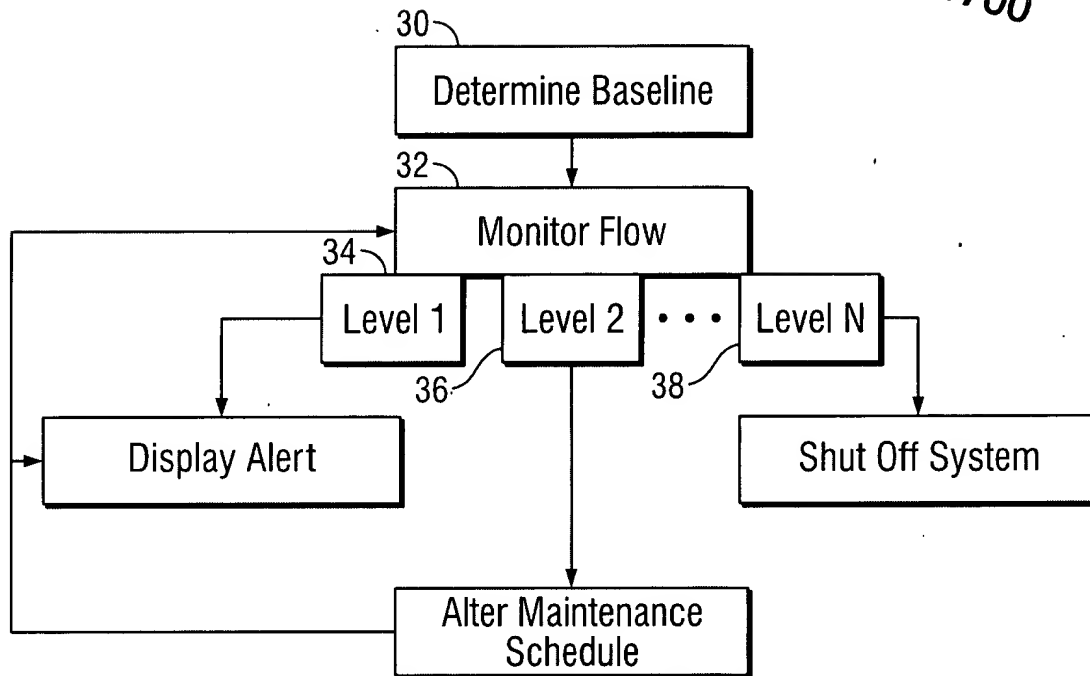


FIG. 5



6/9

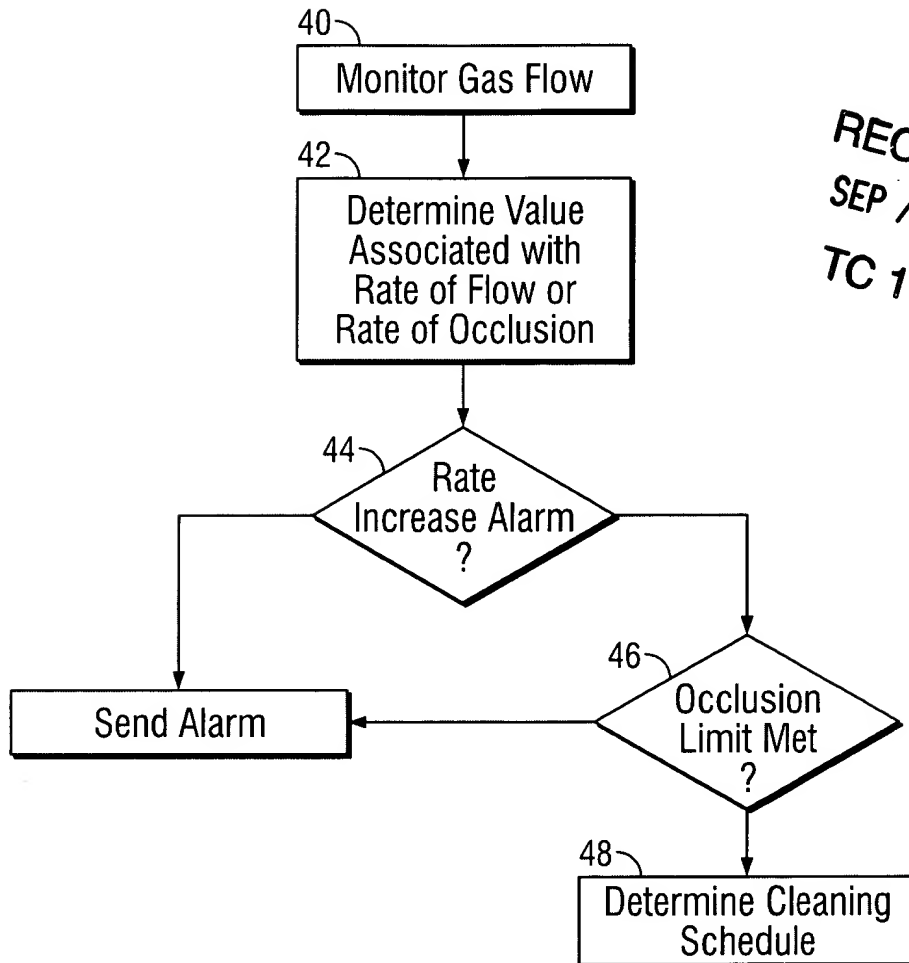


FIG. 6



7/9

RECEIVED  
SEP / 3 2004  
TC 1700

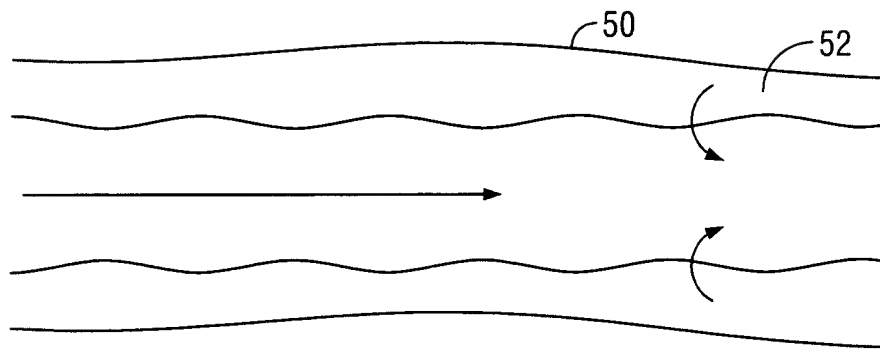


FIG. 7





RECEIVED  
SEP / 3 2004  
TC 1700

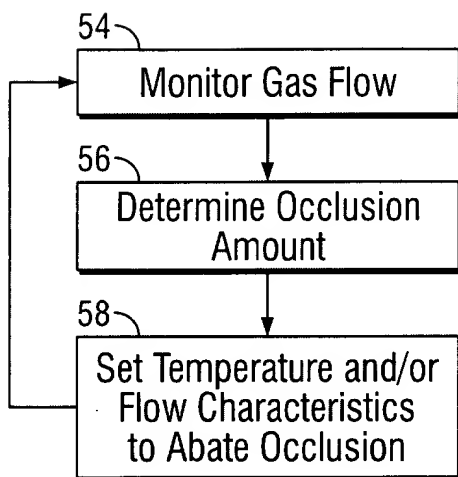


FIG. 8



9/9

RECEIVED  
SEP / 3 2004  
TC 1700

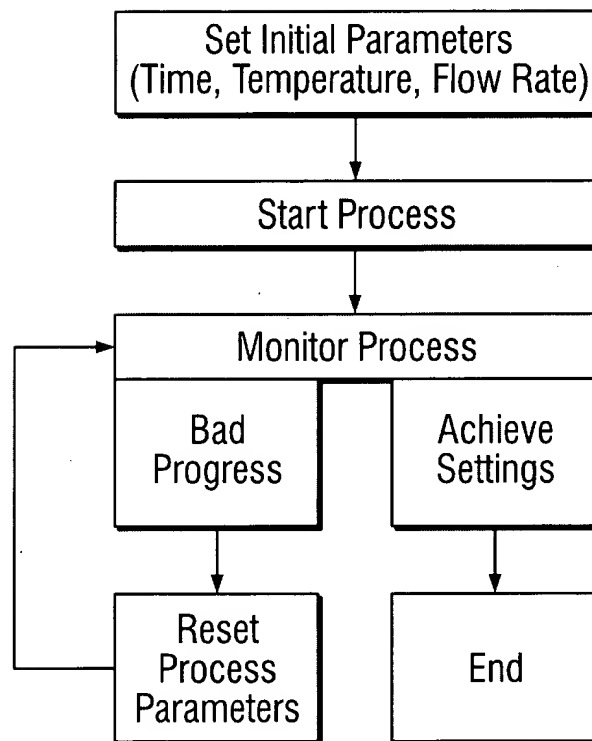


FIG. 9